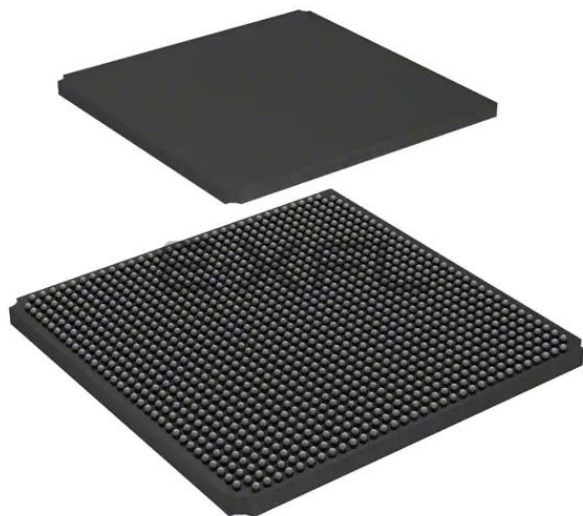




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

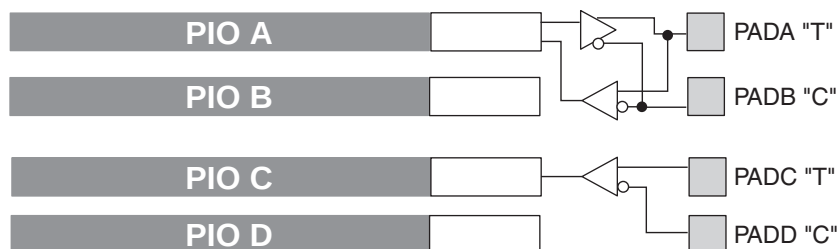
The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Obsolete
Number of LABs/CLBs	20000
Number of Logic Elements/Cells	80000
Total RAM Bits	5816320
Number of I/O	660
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 105°C (TJ)
Package / Case	1152-BBGA
Supplier Device Package	1152-FPBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga80e-6ffn1152i

high-speed interfaces in the LatticeSC devices. Figure 2-18 shows how differential receivers and drivers are arranged between PIOs.

Figure 2-18. Differential Drivers and Receivers



*Differential Driver only available on right and left of the device.

PIO

The PIO contains five blocks: an input register block, output register block, tristate register block, update block, and a control logic block. These blocks contain registers for both single data rate (SDR), double data rate (DDR), and shift register operation along with the necessary clock and selection logic.

Input Register Block

The input register block contains delay elements and registers that can be used to condition signals before they are passed to the device core. Figure 2-20 show the diagram of the input register block. The signal from the PURE-SPEED I/O buffer (DI) enters the input register block and can be used for three purposes, as a source for the combinatorial (INDD) and clock outputs (INCK), the input into the SDR register/latch block and the input to the delay block. The output of the delay block can be used as combinatorial (INDD) and clock (INCK) outputs, an input to the DDR/Shift Register Block or an input into the SDR register block.

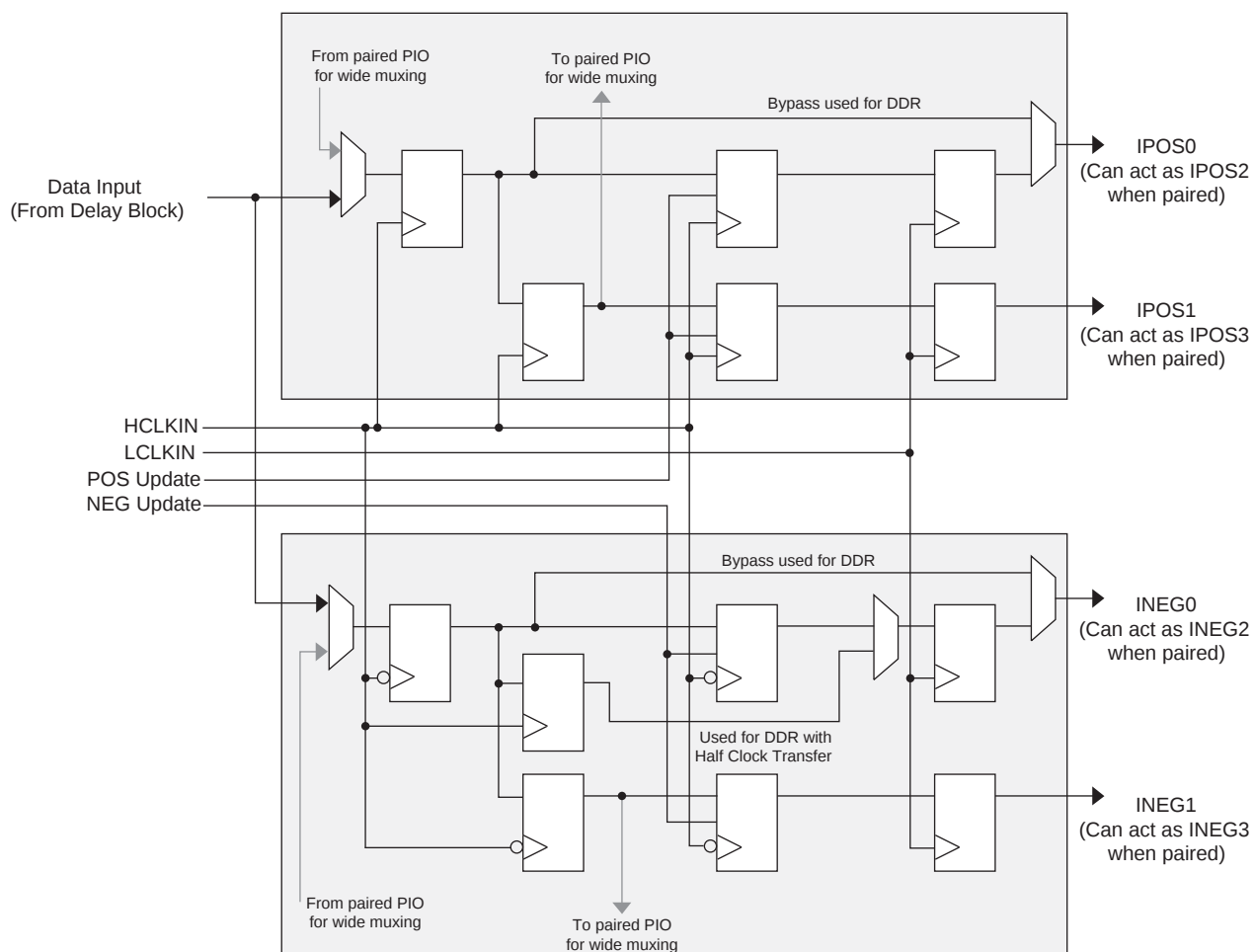
Input SDR Register/Latch Block

The SDR register/latch block has a latch and a register/latch that can be used in a variety of combinations to provide a registered or latched output (INFF). The latch operates off high-speed input clocks and latches data on the positive going edge. The register/latch operates off the low-speed input clock and registers/latches data on the positive going edge. Both the latch and the register/latch have a clock enable input that is driven by the input clock enable. In addition both have a variety of programmable options for set/reset including, set or reset, asynchronous or synchronous Local Set Reset LSR (LSR has precedence over CE) and Global Set Reset GSR enable or disable. The register and latch LSR inputs are driven from LSRI, which is generated from the PIO control MUX. The GSR inputs are driven from the GSR output of the PIO control MUX, which allows the global set-reset to be disabled on a PIO basis.

Input Delay Block

The delay block uses 144 tapped delay lines to obtain coarse and fine delay resolution. These delays can be adjusted during configuration or automatically via DLL or AIL blocks. The Adaptive Input Logic (AIL) uses this delay block to adjust automatically the delay in the data path to ensure that it has sufficient setup and hold time.

The delay line in this block matches the delay line that is used in the 12 on-chip DLLs. The delay line can be set via configuration bits or driven from a calibration bus that allows the setting to be controlled either from one of the on-chip DLLs or user logic. Controlling the delay from one of the on-chip DLLs allow the delay to be calibrated to the DLL clock and hence compensated for the variations in process, voltage and temperature.

Figure 2-21. Input DDR/Shift Register Block

Output Register Block

The output register block provides the ability to register signals from the core of the device before they are passed to the PURESPEED I/O buffers. The block contains a register for SDR operation and a group of registers for DDR and shift register operation. The output signal (DO) can be derived directly from one of the inputs (bypass mode), the SDR register or the DDR/shift register block. Figure 2-22 shows the diagram of the Output Register Block.

Output SDR Register/Latch Block

The SDR register operates on the positive edge of the high-speed clock. It has clock enable that is driven by the clock enable output signal generated by the control MUX. In addition it has a variety of programmable options for set/reset including, set or reset, asynchronous or synchronous Local Set Reset LSR (LSR has precedence over CE) and Global Set Reset GSR enable or disable. The register LSR input is driven from LSRO, which is generated from the PIO control MUX. The GSR inputs is driven from the GSR output of the PIO control MUX, which allows the global set-reset to be disabled on a PIO basis.

Output DDR/Shift Block

The DDR/Shift block contains registers and associated logic that support DDR and shift register functions using the high-speed clock and the associated transfer from the low-speed clock domain. It functions as a gearbox allowing low-speed parallel data from the FPGA fabric be output as a higher speed serial stream. Each PIO supports DDR and x2 shift functions. If desired PIOs A and B or C and D can be combined to form x4 shift functions. Figure 2-22 shows a simplified block diagram of the shift register block.

Differential Input Termination

The LatticeSC device allows two types of differential termination. The first is a single resistor across the differential inputs. The second is a center-tapped system where each input is terminated to the on-chip termination bus V_{CMT} . The V_{CMT} bus is DC-coupled through an internal capacitor to ground.

Figure 2-29 shows the differential termination schemes and Table 2-9 shows the nominal values of the termination resistors.

Figure 2-29. Differential Termination Scheme

Termination Type	Discrete Off-Chip Solution	Lattice On-Chip Solution
Differential termination		
Differential and common mode termination		

Calibration

There are two calibration sources that are associated with the termination scheme used in the LatticeSC devices:

- DIFFR – This pin occurs in each bank that supports differential drivers and must be connected through a 1K+/-1% resistor to ground if differential outputs are used. Note that differential drivers are not supported in banks 1, 4 and 5.
- XRES – There is one of these pins per device. It is used for several functions including calibrating on-chip termination. This pin should always be connected through a 1K+/-1% resistor to ground.

The LatticeSC devices support two modes of calibration:

- Continuous – In this mode the SC devices continually calibrate the termination resistances. Calibration happens several times a second. Using this mode ensures that termination resistances remain calibrated as the silicon junction temperature changes.
- User Request – In this mode the calibration circuit operates continuously. However, the termination resistor values are only updated on the assertion of the calibration_update signal available to the core logic.

For more information on calibration, refer to the details of additional technical documentation at the end of this data sheet.

Hot Socketing

The LatticeSC devices have been carefully designed to ensure predictable behavior during power-up and power-down. To ensure proper power sequencing, care must be taken during power-up and power-down as described below. During power-up and power-down sequences, the I/Os remain in tristate until the power supply voltage is high enough to ensure reliable operation. In addition, leakage into I/O pins is controlled to within specified limits,

flexiPCS quads are not dedicated solely to industry standard protocols. Each quad (and each channel within a quad) can be programmed for many user defined data manipulation modes. For example, modes governing user-defined word alignment and multi-channel alignment can be programmed for non-standard protocol applications.

For more information on the functions and use of the flexiPCS, refer to the [LatticeSC/M Family flexiPCS Data Sheet](#).

System Bus

Each LatticeSC device connects the FPGA elements with a standardized bus framework referred to as a System Bus. Multiple bus masters optimize system performance by sharing resources between different bus masters such as the MPI and configuration logic. The wide data bus configuration of 32 bits with 4-bit parity supports high-bandwidth, data intensive applications.

There are two types of interfaces on the System Bus, master and slave. A master interface has the ability to perform actions on the bus, such as writes and reads to and from a specific address. A slave interface responds to the actions of a master by accepting data and address on a write and providing data on a read. The System Bus has a memory map which describes each of the slave peripherals that is connected on the bus. Using the addresses listed in the memory map, a master interface can access each of the slave peripherals on the System Bus. Any and all peripherals on the System Bus can be used at the same time. Table 2-12 list all of the available user peripherals on the System Bus after device power-up.

Table 2-12. System Bus User Peripherals

Peripheral	Name	Interface Type
Micro Processor Interface	MPI	Master
User Master Interface	UMI	Master
User Slave Interface	USI	Slave
Serial Management Interface (PLL, DLL, User Logic)	SMI	Slave
Physical Coding Sublayer	PCS	Slave
Direct FPGA Access	DFA	Slave

The peripherals listed in Table 2-12 can be added when the System Bus module is created using Module IP/Manager (ispLEVER Module/IP Manager).

Figure 2-31 also lists the existing peripherals on the System Bus. The gray boxes are available only during configuration. Refer to Lattice technical note TN1080, [LatticeSC sysCONFIG Usage Guide](#), for configuration options. The Status and Config box refers to internal System Bus registers. This document presents all the interfaces listed in Table 2-12 in detail to help the user utilize the desired functions of the System Bus.

Power Supply Ramp Rates

Symbol	Parameter	Condition	Min.	Typ.	Max	Units
t_{RAMP}	Power supply ramp rates for all power supplies	Over process, voltage, temperature	3.45	—	—	mV/ μ s
			—	—	75	ms

1. See the Power-up and Power-Down requirements section for more details on power sequencing.
2. From 0.5V to minimum operating voltage.

Hot Socketing Specifications¹

Symbol	Parameter	Condition	Min.	Typ.	Max	Units
I_{DK}	Programmable and dedicated Input or I/O leakage current ^{2, 3, 4, 5, 6}	$0 \leq V_{\text{IN}} \leq V_{\text{IH}} (\text{MAX})$	—	—	± 1500	μ A
I_{HDIN}	SERDES average input current when device powered down and inputs driven ⁷		—	—	4	mA

1. See Hot Socket power up/down information in Chapter 2 of this document.
2. Assumes monotonic rise/fall rates for all power supplies.
3. Sensitive to power supply sequencing as described in hot socketing section.
4. Assumes power supplies are between 0 and maximum recommended operations conditions.
5. I_{DK} is additive to I_{PU} , I_{PD} or I_{BH} .
6. Represents DC conditions. For the first 20ns after hot insertion, current specification is 8 mA.
7. Assumes that the device is powered down with all supplies grounded, both P and N inputs driven by a CML driver with maximum allowed VDDOB of 1.575V, 8b/10b data and internal AC coupling.

DC Electrical Characteristics⁵

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min. ³	Typ.	Max.	Units
$I_{\text{IL}}, I_{\text{IH}}^1$	Input or I/O Low leakage	$0 \leq V_{\text{IN}} \leq V_{\text{IH}} (\text{MAX})$	—	—	10	μ A
I_{PU}	I/O Active Pull-up Current	$0 \leq V_{\text{IN}} \leq 0.7 V_{\text{CCIO}}$	-30	—	-210	μ A
I_{PD}	I/O Active Pull-down Current	$V_{\text{IL}} (\text{MAX}) \leq V_{\text{IN}} \leq V_{\text{IH}} (\text{MAX})$	30	—	210	μ A
I_{BHLS}	Bus Hold Low Sustaining Current	$V_{\text{IN}} = V_{\text{IL}} (\text{MAX})$	30	—	—	μ A
I_{BHHS}	Bus Hold High Sustaining Current	$V_{\text{IN}} = 0.7 V_{\text{CCIO}}$	-30	—	—	μ A
I_{BHLO}	Bus Hold Low Overdrive Current	$0 \leq V_{\text{IN}} \leq V_{\text{IH}} (\text{MAX})$	—	—	210	μ A
I_{BHLH}	Bus Hold High Overdrive Current	$0 \leq V_{\text{IN}} \leq V_{\text{IH}} (\text{MAX})$	—	—	-210	μ A
I_{CL}	PCI Low Clamp Current	$-3 < V_{\text{IN}} \leq -1$	$-25 + (V_{\text{IN}} + 1)/0.015$	—	—	mA
I_{CH}	PCI High Clamp Current	$V_{\text{CC}} + 4 > V_{\text{IN}} \geq V_{\text{CC}} + 1$	$25 + (V_{\text{IN}} - V_{\text{CC}} - 1)/0.015$	—	—	mA
V_{BHT}	Bus Hold trip Points	$0 \leq V_{\text{IN}} \leq V_{\text{IH}} (\text{MAX})$	$V_{\text{IL}} (\text{MAX})$	—	$V_{\text{IH}} (\text{MIN})$	V
C1	I/O Capacitance ²	$V_{\text{CCIO}} = 3.3\text{V}, 2.5\text{V}, 1.8\text{V}, 1.5\text{V}, 1.2\text{V},$ $V_{\text{CC}} = 1.2\text{V}, V_{\text{CCIP2}} = 1.2\text{V},$ $V_{\text{CCAUX}} = 2.5, V_{\text{IO}} = 0 \text{ to } V_{\text{IH}} (\text{MAX})$	—	8	—	pf
C3 ²	Dedicated Input Capacitance ²	$V_{\text{CCIO}} = 3.3\text{V}, 2.5\text{V}, 1.8\text{V}, 1.5\text{V}, 1.2\text{V},$ $V_{\text{CC}} = 1.2\text{V}, V_{\text{CCIP2}} = 1.2\text{V},$ $V_{\text{CCAUX}} = 2.5, V_{\text{IO}} = 0 \text{ to } V_{\text{IH}} (\text{MAX})$	—	6	—	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2. $T_{\text{A}} = 25^{\circ}\text{C}$, $f = 1.0\text{MHz}$
3. I_{PU} , I_{PD} , I_{BHLS} and I_{BHHS} have minimum values of 15 or -15 μ A if V_{CCIO} is set to 1.2V nominal.
4. This table does not apply to SERDES pins.
5. For programmable I/Os.

LatticeSC/M External Switching Characteristics³

Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
General I/O Pin Parameters (using Primary Clock without PLL) ²								
t _{CO}	Global Clock Input to Output - PIO Output Register	2.83	5.74	2.83	6.11	2.83	6.49	ns
t _{SU}	Global Clock Input Setup - PIO Input Register without fixed input delay	-0.66	—	-0.66	—	-0.66	—	ns
t _H	Global Clock Input Hold - PIO Input Register without fixed input delay	1.73	—	1.95	—	2.16	—	ns
t _{SU_IDLY}	Global Clock Input Setup - PIO Input Register with input delay	0.86	—	1.03	—	1.20	—	ns
t _{H_IDLY}	Global Clock Input Hold - PIO Input Register with input delay	-0.17	—	-0.17	—	-0.17	—	ns
f _{MAX_PFU}	Global Clock frequency of PFU register	—	700	—	700	—	700	MHz
f _{MAX_IO}	Global Clock frequency of I/O register	—	1000	—	1000	—	1000	MHz
t _{GC_SKEW}	Global Clock skew	—	89	—	103	—	116	ps
General I/O Pin Parameters (using Primary Clock with PLL) ^{1, 2}								
t _{CO}	Global Clock Input to Output - PIO Output Register	2.25	4.81	2.25	5.08	2.25	5.37	ns
t _{SU}	Global Clock Input Setup - PIO Input Register without fixed input delay	-0.07	—	-0.07	—	-0.07	—	ns
t _H	Global Clock Input Hold - PIO Input Register without fixed input delay	0.80	—	0.93	—	1.04	—	ns
General I/O Pin Parameters (using Edge Clock without PLL) ²								
t _{CO}	Edge Clock Input to Output - PIO Output Register	2.38	4.77	2.38	5.04	2.38	5.33	ns
t _{SU}	Edge Clock Input Setup - PIO Input Register without fixed input delay	-0.08	—	-0.08	—	-0.08	—	ns
t _H	Edge Clock Input Hold - PIO Input Register	0.49	—	0.58	—	0.66	—	ns
t _{SU_IDLY}	Edge Clock Input Setup - PIO Input Register with input delay	0.81	—	0.97	—	1.12	—	ns
t _{H_IDLY}	Edge Clock Input Hold - PIO Input Register with input delay	-0.34	—	-0.34	—	-0.34	—	ns
t _{EC_SKEW}	Edge Clock skew	—	28	—	32	—	36	ps
General I/O Pin Parameters (using Latch FF without PLL) ²								
t _{SU}	Latch FF, Input Setup - PIO Input Register without fixed input delay	-0.14	—	-0.14	—	-0.14	—	ns
t _H	Latch FF, Input Hold - PIO Input Register without fixed input delay	0.58	—	0.68	—	0.77	—	ns
t _{SU_IDLY}	Latch FF, Input Setup - PIO Input Register with input delay	0.70	—	0.68	—	0.77	—	ns
t _{H_IDLY}	Latch FF, Input Hold - PIO Input Register with input delay	-0.30	—	-0.30	—	-0.30	—	ns

1. No PLL delay tuning (clock injection removal mode, system clock feedback).

2. Using LVCMOS25 12mA I/O. Timing adders for other supported I/O technologies are specified in the LatticeSC Family Timing Adders table.

3. Complete Timing Parameters for a user design are incorporated when running ispLEVER. This is a sampling of the key timing parameters.

Timing specs are for non-AIL applications.

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
W24	VCCAUX	-		VCCAUX	-	
AC17	VCCAUX	-		VCCAUX	-	
AC18	VCCAUX	-		VCCAUX	-	
AC19	VCCAUX	-		VCCAUX	-	
AD17	VCCAUX	-		VCCAUX	-	
AD18	VCCAUX	-		VCCAUX	-	
AD19	VCCAUX	-		VCCAUX	-	
AC12	VCCAUX	-		VCCAUX	-	
AC13	VCCAUX	-		VCCAUX	-	
AC14	VCCAUX	-		VCCAUX	-	
AD12	VCCAUX	-		VCCAUX	-	
AD13	VCCAUX	-		VCCAUX	-	
AD14	VCCAUX	-		VCCAUX	-	
U7	VCCAUX	-		VCCAUX	-	
U8	VCCAUX	-		VCCAUX	-	
V7	VCCAUX	-		VCCAUX	-	
V8	VCCAUX	-		VCCAUX	-	
W7	VCCAUX	-		VCCAUX	-	
W8	VCCAUX	-		VCCAUX	-	
M7	VCCAUX	-		VCCAUX	-	
M8	VCCAUX	-		VCCAUX	-	
N7	VCCAUX	-		VCCAUX	-	
N8	VCCAUX	-		VCCAUX	-	
H10	VCCIO1	-		VCCIO1	-	
H21	VCCIO1	-		VCCIO1	-	
H22	VCCIO1	-		VCCIO1	-	
H9	VCCIO1	-		VCCIO1	-	
J11	VCCIO1	-		VCCIO1	-	
J12	VCCIO1	-		VCCIO1	-	
J13	VCCIO1	-		VCCIO1	-	
J14	VCCIO1	-		VCCIO1	-	
J15	VCCIO1	-		VCCIO1	-	
J16	VCCIO1	-		VCCIO1	-	
J17	VCCIO1	-		VCCIO1	-	
J18	VCCIO1	-		VCCIO1	-	
J19	VCCIO1	-		VCCIO1	-	
J20	VCCIO1	-		VCCIO1	-	
J23	VCCIO2	-		VCCIO2	-	
J24	VCCIO2	-		VCCIO2	-	
K23	VCCIO2	-		VCCIO2	-	
K24	VCCIO2	-		VCCIO2	-	
L22	VCCIO2	-		VCCIO2	-	
L23	VCCIO2	-		VCCIO2	-	
M22	VCCIO2	-		VCCIO2	-	
N22	VCCIO2	-		VCCIO2	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
P10	GND	-		GND	-	
P13	GND	-		GND	-	
P15	GND	-		GND	-	
P18	GND	-		GND	-	
P20	GND	-		GND	-	
P24	GND	-		GND	-	
R12	GND	-		GND	-	
R14	GND	-		GND	-	
R16	GND	-		GND	-	
R17	GND	-		GND	-	
R19	GND	-		GND	-	
R21	GND	-		GND	-	
R26	GND	-		GND	-	
R6	GND	-		GND	-	
T15	GND	-		GND	-	
T18	GND	-		GND	-	
T30	GND	-		GND	-	
T4	GND	-		GND	-	
U15	GND	-		GND	-	
U18	GND	-		GND	-	
U29	GND	-		GND	-	
U3	GND	-		GND	-	
V12	GND	-		GND	-	
V14	GND	-		GND	-	
V16	GND	-		GND	-	
V17	GND	-		GND	-	
V19	GND	-		GND	-	
V21	GND	-		GND	-	
V27	GND	-		GND	-	
V7	GND	-		GND	-	
W13	GND	-		GND	-	
W15	GND	-		GND	-	
W18	GND	-		GND	-	
W20	GND	-		GND	-	
W23	GND	-		GND	-	
W9	GND	-		GND	-	
Y12	GND	-		GND	-	
Y14	GND	-		GND	-	
Y19	GND	-		GND	-	
Y21	GND	-		GND	-	
Y30	GND	-		GND	-	
Y4	GND	-		GND	-	
N13	VCC	-		VCC	-	
N15	VCC	-		VCC	-	
N16	VCC	-		VCC	-	
N17	VCC	-		VCC	-	
N18	VCC	-		VCC	-	
N20	VCC	-		VCC	-	
P14	VCC	-		VCC	-	
P16	VCC	-		VCC	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
G27	A_REFCLKP_L	-		A_REFCLKP_L	-	
H27	A_REFCLKN_L	-		A_REFCLKN_L	-	
H25	VCC12	-		VCC12	-	
H26	RESP_ULC	-		RESP_ULC	-	
B33	RESETN	1		RESETN	1	
C34	TSALLN	1		TSALLN	1	
D34	DONE	1		DONE	1	
C33	INITN	1		INITN	1	
J27	M0	1		M0	1	
K27	M1	1		M1	1	
M26	M2	1		M2	1	
L26	M3	1		M3	1	
F30	PL16A	7	ULC_PLLT_IN_A/ULC_PLLT_FB_B	PL16A	7	ULC_PLLT_IN_A/ULC_PLLT_FB_B
G30	PL16B	7	ULC_PLLC_IN_A/ULC_PLLC_FB_B	PL16B	7	ULC_PLLC_IN_A/ULC_PLLC_FB_B
H28	PL16C	7		PL16C	7	
J28	PL16D	7		PL16D	7	
F31	PL17A	7	ULC_DLLT_IN_C/ULC_DLLT_FB_D	PL17A	7	ULC_DLLT_IN_C/ULC_DLLT_FB_D
G31	PL17B	7	ULC_DLLC_IN_C/ULC_DLLC_FB_D	PL17B	7	ULC_DLLC_IN_C/ULC_DLLC_FB_D
N25	PL17C	7	ULC_PLLT_IN_B/ULC_PLLT_FB_A	PL17C	7	ULC_PLLT_IN_B/ULC_PLLT_FB_A
P25	PL17D	7	ULC_PLLC_IN_B/ULC_PLLC_FB_A	PL17D	7	ULC_PLLC_IN_B/ULC_PLLC_FB_A
D33	PL18A	7	ULC_DLLT_IN_D/ULC_DLLT_FB_C	PL18A	7	ULC_DLLT_IN_D/ULC_DLLT_FB_C
E33	PL18B	7	ULC_DLLC_IN_D/ULC_DLLC_FB_C	PL18B	7	ULC_DLLC_IN_D/ULC_DLLC_FB_C
H29	PL18C	7		PL18C	7	
J29	PL18D	7	VREF2_7	PL18D	7	VREF2_7
F32	PL21A	7		PL20A	7	
G32	PL21B	7		PL20B	7	
P26	PL21C	7		PL20C	7	
N26	PL21D	7		PL20D	7	
H30	PL22A	7		PL21A	7	
J30	PL22B	7		PL21B	7	
L28	PL22C	7		PL21C	7	
M28	PL22D	7		PL21D	7	
J31	PL23A	7		PL29A	7	
K31	PL23B	7		PL29B	7	
L27	PL23C	7	VREF1_7	PL29C	7	VREF1_7
M27	PL23D	7	DIFFR_7	PL29D	7	DIFFR_7
J32	PL25A	7		PL31A	7	
K32	PL25B	7		PL31B	7	
L29	PL25C	7		PL31C	7	
M29	PL25D	7		PL31D	7	
H33	PL26A	7		PL33A	7	
J33	PL26B	7		PL33B	7	
N27	PL26C	7		PL33C	7	
P27	PL26D	7		PL33D	7	
K33	PL27A	7		PL35A	7	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AD29	PL60D	6		PL84D	6	
AE31	PL61A	6		PL85A	6	
AF31	PL61B	6		PL85B	6	
AF30	PL61C	6		PL85C	6	
AF29	PL61D	6		PL85D	6	
AH33	PL62A	6		PL86A	6	
AJ33	PL62B	6		PL86B	6	
AC28	PL62C	6		PL86C	6	
AD28	PL62D	6		PL86D	6	
AH32	PL65A	6		PL89A	6	
AJ32	PL65B	6		PL89B	6	
AD27	PL65C	6		PL89C	6	
AE27	PL65D	6	VREF2_6	PL89D	6	VREF2_6
AG34	PL66A	6		PL90A	6	
AH34	PL66B	6		PL90B	6	
AC26	PL66C	6		PL90C	6	
AB26	PL66D	6		PL90D	6	
AK33	PL67A	6		PL91A	6	
AL33	PL67B	6		PL91B	6	
AG30	PL67C	6		PL91C	6	
AH30	PL67D	6		PL91D	6	
AL34	PL69A	6		PL93A	6	
AM34	PL69B	6		PL93B	6	
AJ30	PL69C	6	LLC_DLLT_IN_E/LLC_DLLT_FB_F	PL93C	6	LLC_DLLT_IN_E/LLC_DLLT_FB_F
AK30	PL69D	6	LLC_DLLC_IN_E/LLC_DLLC_FB_F	PL93D	6	LLC_DLLC_IN_E/LLC_DLLC_FB_F
AJ31	PL70A	6		PL94A	6	
AH31	PL70B	6		PL94B	6	
AD26	PL70C	6		PL94C	6	
AD25	PL70D	6		PL94D	6	
AL32	PL71A	6	LLC_DLLT_IN_F/LLC_DLLT_FB_E	PL95A	6	LLC_DLLT_IN_F/LLC_DLLT_FB_E
AL31	PL71B	6	LLC_DLLC_IN_F/LLC_DLLC_FB_E	PL95B	6	LLC_DLLC_IN_F/LLC_DLLC_FB_E
AG29	PL71C	6	LLC_PLLT_IN_B/LLC_PLLT_FB_A	PL95C	6	LLC_PLLT_IN_B/LLC_PLLT_FB_A
AG28	PL71D	6	LLC_PLLC_IN_B/LLC_PLLC_FB_A	PL95D	6	LLC_PLLC_IN_B/LLC_PLLC_FB_A
AF28	XRES	-		XRES	-	
AF27	TEMP	6		TEMP	6	
AM33	PB3A	5	LLC_PLLT_IN_A/LLC_PLLT_FB_B	PB3A	5	LLC_PLLT_IN_A/LLC_PLLT_FB_B
AN33	PB3B	5	LLC_PLLC_IN_A/LLC_PLLC_FB_B	PB3B	5	LLC_PLLC_IN_A/LLC_PLLC_FB_B
AH29	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D
AJ29	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D
AM32	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C
AM31	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C
AG27	PB4C	5		PB4C	5	
AG26	PB4D	5		PB4D	5	
AL29	PB5A	5		PB5A	5	
AL28	PB5B	5		PB5B	5	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
Y4	PR48B	3		PR63B	3	
W4	PR48A	3		PR63A	3	
W11	PR47D	3		PR60D	3	
V11	PR47C	3		PR60C	3	
W2	PR47B	3		PR60B	3	
V2	PR47A	3		PR60A	3	
W9	PR45D	3		PR57D	3	
V9	PR45C	3		PR57C	3	
V1	PR45B	3		PR57B	3	
U1	PR45A	3		PR57A	3	
W10	PR44D	3		PR56D	3	
V10	PR44C	3		PR56C	3	
U2	PR44B	3		PR56B	3	
T2	PR44A	3		PR56A	3	
Y8	PR43D	3		PR55D	3	
W8	PR43C	3	VREF1_3	PR55C	3	VREF1_3
W5	PR43B	3		PR55B	3	
V5	PR43A	3		PR55A	3	
V7	PR40D	3	PCLKC3_2	PR52D	3	PCLKC3_2
U7	PR40C	3	PCLKT3_2	PR52C	3	PCLKT3_2
T1	PR40B	3		PR52B	3	
R1	PR40A	3		PR52A	3	
V8	PR39D	3	PCLKC3_3	PR51D	3	PCLKC3_3
U8	PR39C	3	PCLKT3_3	PR51C	3	PCLKT3_3
U5	PR39B	3		PR51B	3	
T5	PR39A	3		PR51A	3	
V6	PR38D	3	PCLKC3_1	PR50D	3	PCLKC3_1
U6	PR38C	3	PCLKT3_1	PR50C	3	PCLKT3_1
T4	PR38B	3	PCLKC3_0	PR50B	3	PCLKC3_0
T3	PR38A	3	PCLKT3_0	PR50A	3	PCLKT3_0
U9	PR36D	2	PCLKC2_2	PR48D	2	PCLKC2_2
T9	PR36C	2	PCLKT2_2	PR48C	2	PCLKT2_2
R2	PR36B	2	PCLKC2_0	PR48B	2	PCLKC2_0
P2	PR36A	2	PCLKT2_0	PR48A	2	PCLKT2_0
T11	PR35D	2	PCLKC2_3	PR47D	2	PCLKC2_3
U11	PR35C	2	PCLKT2_3	PR47C	2	PCLKT2_3
R4	PR35B	2	PCLKC2_1	PR47B	2	PCLKC2_1
R3	PR35A	2	PCLKT2_1	PR47A	2	PCLKT2_1
T8	PR34D	2		PR46D	2	
R8	PR34C	2		PR46C	2	
P1	PR34B	2		PR46B	2	
N1	PR34A	2		PR46A	2	
R6	PR31D	2		PR43D	2	
P6	PR31C	2		PR43C	2	
M1	PR31B	2		PR43B	2	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
L21	PT55D	1	A16/MPI_ADDR30
L20	PT55C	1	D13/MPI_DATA13
D20	PT55B	1	A15/MPI_ADDR29
E20	PT55A	1	A17/MPI_ADDR31
L19	PT54D	1	A19/MPI_TSI_Z1
K19	PT54C	1	A20/MPI_BDIP
D21	PT54B	1	A18/MPI_TSI_Z0
E21	PT54A	1	MPI_TEA
M20	PT51D	1	D14/MPI_DATA14
M19	PT51C	1	DP1/MPI_PAR1
F21	PT51B	1	A21/MPI_BURST
G21	PT51A	1	D15/MPI_DATA15
H24	B_REFCLKP_L	-	
J24	B_REFCLKN_L	-	
L22	VCC12	-	
E26	B_VDDIB3_L	-	
G22	VCC12	-	
E22	B_HDINP3_L	-	PCS 361 CH 3 IN P
F22	B_HDINN3_L	-	PCS 361 CH 3 IN N
A21	B_HDOUTP3_L	-	PCS 361 CH 3 OUT P
L24	VCC12	-	
B21	B_HDOUTN3_L	-	PCS 361 CH 3 OUT N
D22	B_VDDOB3_L	-	
B22	B_HDOUTN2_L	-	PCS 361 CH 2 OUT N
D23	B_VDDOB2_L	-	
A22	B_HDOUTP2_L	-	PCS 361 CH 2 OUT P
K24	VCC12	-	
F23	B_HDINN2_L	-	PCS 361 CH 2 IN N
E23	B_HDINP2_L	-	PCS 361 CH 2 IN P
D26	B_VDDIB2_L	-	
G23	VCC12	-	
D27	B_VDDIB1_L	-	
G24	VCC12	-	
E24	B_HDINP1_L	-	PCS 361 CH 1 IN P
F24	B_HDINN1_L	-	PCS 361 CH 1 IN N
A23	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P
L25	VCC12	-	
B23	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N
D24	B_VDDOB1_L	-	
B24	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N
D25	B_VDDOB0_L	-	
A24	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P
K25	VCC12	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
H34	PL40B	7	
M32	PL53A	7	
N32	PL53B	7	
P28	PL53C	7	
R28	PL53D	7	
J34	PL55A	7	
K34	PL55B	7	
P30	PL55C	7	
R30	PL55D	7	
W34	PL73A	6	
Y34	PL73B	6	
W32	PL75A	6	
Y32	PL75B	6	
AA34	PL78A	6	
AB34	PL78B	6	
AC34	PL81A	6	
AD34	PL81B	6	
Y30	PL82A	6	
AA30	PL82B	6	
AB33	PL83A	6	
AC33	PL83B	6	
AC2	PR83B	3	
AB2	PR83A	3	
AA5	PR82B	3	
Y5	PR82A	3	
AD1	PR81B	3	
AC1	PR81A	3	
AB1	PR78B	3	
AA1	PR78A	3	
Y3	PR75B	3	
W3	PR75A	3	
Y1	PR73B	3	
W1	PR73A	3	
R5	PR55D	2	
P5	PR55C	2	
K1	PR55B	2	
J1	PR55A	2	
R7	PR53D	2	
P7	PR53C	2	
N3	PR53B	2	
M3	PR53A	2	
H1	PR40B	2	
G1	PR40A	2	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
U22	VCCAUX	-	
V13	VCCAUX	-	
V22	VCCAUX	-	
V23	VCCAUX	-	
W13	VCCAUX	-	
W22	VCCAUX	-	
Y21	GND	-	
Y25	GND	-	
C18	VCCIO1	-	
D17	VCCIO1	-	
F16	VCCIO1	-	
G19	VCCIO1	-	
J20	VCCIO1	-	
K12	VCCIO1	-	
K15	VCCIO1	-	
L23	VCCIO1	-	
Y9	GND	-	
J9	VCCIO1	-	
E3	VCCIO2	-	
G6	VCCIO2	-	
H4	VCCIO2	-	
K7	VCCIO2	-	
L3	VCCIO2	-	
M11	VCCIO2	-	
N6	VCCIO2	-	
P4	VCCIO2	-	
R9	VCCIO2	-	
AA3	VCCIO3	-	
AB7	VCCIO3	-	
AC10	VCCIO3	-	
AD4	VCCIO3	-	
AE6	VCCIO3	-	
AG3	VCCIO3	-	
AK4	VCCIO3	-	
T7	VCCIO3	-	
U3	VCCIO3	-	
V4	VCCIO3	-	
W6	VCCIO3	-	
Y10	VCCIO3	-	
AD12	VCCIO4	-	
AF15	VCCIO4	-	
AF9	VCCIO4	-	
AH10	VCCIO4	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AH16	VCCIO4	-	
AJ13	VCCIO4	-	
AJ7	VCCIO4	-	
AL14	VCCIO4	-	
AL8	VCCIO4	-	
AM11	VCCIO4	-	
AM17	VCCIO4	-	
AM5	VCCIO4	-	
AE20	VCCIO5	-	
AE23	VCCIO5	-	
AE26	VCCIO5	-	
AH22	VCCIO5	-	
AH28	VCCIO5	-	
AJ19	VCCIO5	-	
AJ25	VCCIO5	-	
AL18	VCCIO5	-	
AL24	VCCIO5	-	
AL30	VCCIO5	-	
AM21	VCCIO5	-	
AM27	VCCIO5	-	
AA31	VCCIO6	-	
AB29	VCCIO6	-	
AC24	VCCIO6	-	
AD32	VCCIO6	-	
AE28	VCCIO6	-	
AG31	VCCIO6	-	
AK32	VCCIO6	-	
T29	VCCIO6	-	
U31	VCCIO6	-	
V32	VCCIO6	-	
W28	VCCIO6	-	
Y26	VCCIO6	-	
E31	VCCIO7	-	
G28	VCCIO7	-	
H32	VCCIO7	-	
K29	VCCIO7	-	
L31	VCCIO7	-	
M25	VCCIO7	-	
N28	VCCIO7	-	
P32	VCCIO7	-	
R25	VCCIO7	-	
J25	VCCIO1	-	
N11	VTT_2	2	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCI/O Bank	Dual Function	Ball Function	VCCI/O Bank	Dual Function
AY41	PB12A	5		PB13A	5	
BA41	PB12B	5		PB13B	5	
AT39	PB12C	5		PB13C	5	
AT38	PB12D	5		PB13D	5	
AV37	PB13A	5		PB15A	5	
AV36	PB13B	5		PB15B	5	
AM31	PB13C	5		PB15C	5	
AM32	PB13D	5		PB15D	5	
BA40	PB15A	5		PB16A	5	
BB40	PB15B	5		PB16B	5	
AM29	PB15C	5		PB16C	5	
AL29	PB15D	5		PB16D	5	
AY39	PB16A	5		PB17A	5	
AY38	PB16B	5		PB17B	5	
AN33	PB16C	5		PB17C	5	
AN32	PB16D	5		PB17D	5	
BA39	PB17A	5		PB19A	5	
BA38	PB17B	5		PB19B	5	
AT37	PB17C	5		PB19C	5	
AT36	PB17D	5		PB19D	5	
AW36	PB19A	5		PB20A	5	
AW35	PB19B	5		PB20B	5	
AM28	PB19C	5		PB20C	5	
AL28	PB19D	5		PB20D	5	
BB38	PB20A	5		PB21A	5	
BB39	PB20B	5		PB21B	5	
AR34	PB20C	5		PB21C	5	
AR33	PB20D	5		PB21D	5	
AV35	PB21A	5		PB23A	5	
AV34	PB21B	5		PB23B	5	
AT33	PB21C	5		PB23C	5	
AT34	PB21D	5		PB23D	5	
BA37	PB23A	5		PB25A	5	
BA36	PB23B	5		PB25B	5	
AP33	PB23C	5		PB25C	5	
AP32	PB23D	5		PB25D	5	
AY36	PB24A	5		PB26A	5	
AY35	PB24B	5		PB26B	5	
AN31	PB24C	5		PB26C	5	
AN30	PB24D	5		PB26D	5	
BB37	PB25A	5		PB27A	5	
BB36	PB25B	5		PB27B	5	
AP31	PB25C	5		PB27C	5	
AP30	PB25D	5		PB27D	5	
AV33	PB27A	5		PB29A	5	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AV32	PB27B	5		PB29B	5	
AU36	PB27C	5		PB29C	5	
AU37	PB27D	5		PB29D	5	
BA35	PB28A	5		PB30A	5	
BA34	PB28B	5		PB30B	5	
AJ26	PB28C	5		PB30C	5	
AJ27	PB28D	5		PB30D	5	
AW33	PB29A	5		PB31A	5	
AW32	PB29B	5		PB31B	5	
AU35	PB29C	5		PB31C	5	
AU34	PB29D	5		PB31D	5	
BB35	PB31A	5		PB33A	5	
BB34	PB31B	5		PB33B	5	
AN29	PB31C	5		PB33C	5	
AP29	PB31D	5		PB33D	5	
AY33	PB32A	5		PB34A	5	
AY32	PB32B	5		PB34B	5	
AR31	PB32C	5		PB34C	5	
AR30	PB32D	5		PB34D	5	
AV31	PB33A	5		PB35A	5	
AV30	PB33B	5		PB35B	5	
AN28	PB33C	5		PB35C	5	
AP28	PB33D	5		PB35D	5	
BA33	PB35A	5		PB37A	5	
BA32	PB35B	5		PB37B	5	
AT30	PB35C	5		PB37C	5	
AT31	PB35D	5		PB37D	5	
BB33	PB36A	5		PB38A	5	
BB32	PB36B	5		PB38B	5	
AM26	PB36C	5		PB38C	5	
AL26	PB36D	5		PB38D	5	
AW30	PB37A	5		PB39A	5	
AW29	PB37B	5		PB39B	5	
AP27	PB37C	5		PB39C	5	
AN27	PB37D	5		PB39D	5	
BA31	PB39A	5		PB41A	5	
BA30	PB39B	5		PB41B	5	
AU32	PB39C	5		PB41C	5	
AU33	PB39D	5		PB41D	5	
BB31	PB40A	5		PB42A	5	
BB30	PB40B	5		PB42B	5	
AR28	PB40C	5		PB42C	5	
AR27	PB40D	5		PB42D	5	
AV29	PB41A	5		PB43A	5	
AV28	PB41B	5		PB43B	5	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
V8	PR41C	2		PR55C	2	
T4	PR41B	2		PR55B	2	
U4	PR41A	2		PR55A	2	
V9	PR39D	2		PR53D	2	
U9	PR39C	2		PR53C	2	
V6	PR39B	2		PR53B	2	
U6	PR39A	2		PR53A	2	
AA12	PR38D	2		PR52D	2	
Y12	PR38C	2		PR52C	2	
P1	PR38B	2		PR52B	2	
N1	PR38A	2		PR52A	2	
T7	PR37D	2		PR51D	2	
R7	PR37C	2		PR51C	2	
T5	PR37B	2		PR51B	2	
R5	PR37A	2		PR51A	2	
U10	PR35D	2		PR49D	2	
V10	PR35C	2		PR49C	2	
P2	PR35B	2		PR49B	2	
N2	PR35A	2		PR49A	2	
T8	PR34D	2		PR48D	2	
R8	PR34C	2		PR48C	2	
N3	PR34B	2		PR48B	2	
P3	PR34A	2		PR48A	2	
M6	PR33D	2		PR47D	2	
M7	PR33C	2		PR47C	2	
T6	PR33B	2		PR47B	2	
R6	PR33A	2		PR47A	2	
V11	PR31D	2		PR45D	2	
U11	PR31C	2		PR45C	2	
M1	PR31B	2		PR45B	2	
L1	PR31A	2		PR45A	2	
Y14	PR30D	2		PR44D	2	
W14	PR30C	2		PR44C	2	
M2	PR30B	2		PR44B	2	
L2	PR30A	2		PR44A	2	
T9	PR29D	2	DIFFR_2	PR43D	2	DIFFR_2
R9	PR29C	2	VREF1_2	PR43C	2	VREF1_2
P4	PR29B	2		PR43B	2	
N4	PR29A	2		PR43A	2	
N7	PR26D	2		PR40D	2	
N8	PR26C	2		PR40C	2	
P5	PR26B	2		PR40B	2	
N5	PR26A	2		PR40A	2	
K7	PR25D	2		PR38D	2	
J7	PR25C	2		PR38C	2	

Thermal Management

Thermal management is recommended as part of any sound FPGA design methodology. To assess the thermal characteristics of a system, Lattice specifies a maximum allowable junction temperature in all device data sheets. Designers must complete a thermal analysis of their specific design to ensure that the device and package do not exceed the junction temperature limits. Refer to the Thermal Management document to find the device/package specific thermal values.

For Further Information

For further information regarding Thermal Management, refer to the following located on the Lattice website at www.latticesemi.com.

- Thermal Management document
- Technical Note TN1101 - Power Estimation and Management for LatticeSC Devices
- Power Calculator tool included with Lattice's ispLEVER design tool, or as a standalone download from www.latticesemi.com/software

Date	Version	Section	Change Summary
August 2006 (cont.)	01.3 (cont.)	DC and Switching Characteristics (cont.)	Updated LatticeSC Family Timing Adders with ispLEVER 6.0 SP1 results
			Updated PLL Timing Parameters based on PDE testing results
			Removed RDDATA parameter from sysCONFIG readback timing table
		Multiple	Changed TDO/RDDATA to TDO
		Pinout Information	Removed all MPI signals from SC15 256 pin package Dual Function Column
			Added note to SC15, SC25 900 pin package that the package supports a 16 bit MPI
			Added note that pin D3 in an SC15 and SC25 900 pin package should not be used for single-ended outputs
			Added note that pin D28 in an SC15 and SC25 900 pin package should not be used for single-ended outputs
			Added note to SC25 1020 pin package that the package supports a 16 bit MPI
			Added note to SC80 1152 pin package that the package supports a 32 bit MPI
			Added note to SC80 1704 pin package that the package supports a 32 bit MPI
		Ordering Information	Changed “fcBGA” for the 1020 packages to “ffBGA”
November 2006	01.4	Introduction	LatticeSC Family Selection Guide table – I/O count for SC80 device, 1704 fcBGA package changed to 904/32. I/O count for SC115 device, 1704 fcBGA package changed to 942/32.
		DC and Switching Characteristics	DC Electrical Characteristics table – Updated the initialization and standby supply current values.
			DC Electrical Characteristics table – Updated the sysCONFIG Master Parallel mode RCLK low and RCLK high time specifications.
			DC Electrical Characteristics table – Updated VCCIO values for LVPECL33 I/Os.
		Pin Information	Pin Information Summary table - Changed number of single ended user I/Os from 906 to 904 for 1704 fcBGA.
			Removed the single-ended only output restriction on pins D3 and D28 in an SC15 and SC25 900 pin package.
		Ordering Information	Ordering Information tables - Changed number of I/Os from 906 to 904 for 1704 fcBGA.
			Added ordering part numbers for LatticeSC/SCM 40K and 115K LUT devices.
			Added lead-free ordering part numbers.
		Multiple	Changed number of available SC80 I/O from 906 to 904. Changed number of available SC115 I/O from 944 to 942.
January 2007	01.4a	Architecture	Added EBR Asynchronous Reset section.
February 2007	01.4b	Architecture	Updated EBR Asynchronous Reset section.
March 2007	01.5	Architecture	Added EBR asynchronous reset clarification
			Clarified that differential drivers are not supported in banks 1, 4 and 5
		DC and Switching Characteristics	Added clarification for the description of the junction temperature specification in the Absolute Maximum Ratings section.
			Updated Initialization and Standby Current table. Updated LatticeSC External Switching Characteristics with ispLEVER 6.1 SP1 results.